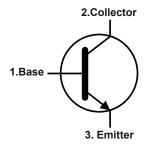


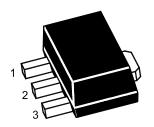
#### **Features**

- For AF driver and output stages
- High collector current
- Low collector-emitter saturation voltage

## **Equivalent Circuit**

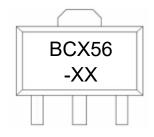


#### **SOT-89**



1.Base 2.Collector 3. Emitter

#### Marking Code:



XX: 10/16

## **Absolute Maximum Ratings**

Ratings at 25°C ambient temperature unless otherwise specified.

Parameter	Symbol	Value	Unit
Collector Base Voltage	V <sub>CBO</sub>	100	V
Collector Emitter Voltage	V <sub>CEO</sub>	80	V
Emitter Base Voltage	V <sub>EBO</sub>	5	V
Collector Current	Ic	1	Α
Peak Collector Current	I <sub>CM</sub>	1.5	Α
Maximum Power Dissipation	P <sub>D</sub>	0.5 Note1 1.3 Note2	W
Junction Temperature	TJ	150	°C
Storage Temperature Range	T <sub>STG</sub>	-65 to +150	°C

Note: 1. Device mounted on an FR4 Printed-Circuit Board(PCB), single-sided copper, tin-plated and standard footprint.

2. Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 6 cm<sup>2</sup>

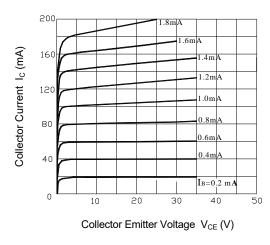


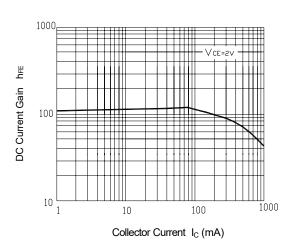
# Electrical Characteristics (T<sub>A</sub>=25°C)

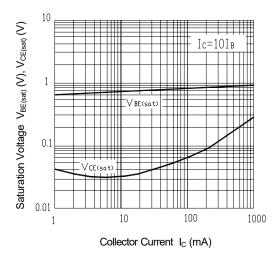
Parameter		Symbol	Min.	Тур.	Max.	Unit
DC Current Gain						
at $V_{CE}$ = 2 V, $I_C$ = 5 mA			40			
at $V_{CE}$ = 2 V, $I_C$ = 150 mA	BCX56SQ-10	H <sub>FE</sub>	63		160	
	BCX56SQ-16		100		250	
at $V_{CE}$ = 2 V, $I_C$ = 500 mA			25			
Collector Base Cutoff Current		1			100	nA
at V <sub>CB</sub> = 30V		I <sub>CBO</sub>			100	IIA
Emitter Base Cutoff Current		I			100	nA
at V <sub>EB</sub> = 5 V		I <sub>EBO</sub>				
Collector Base Breakdown Voltage		V <sub>(BR)CBO</sub>				V
at I <sub>C</sub> = 100 μA						
Collector Emitter Breakdown Voltage						V
at I <sub>C</sub> = 1 mA		V <sub>(BR)CEO</sub>	80			V
Emitter Base Breakdown Voltage		\/	5			V
at $I_E = 100 \mu A$		V <sub>(BR)EBO</sub>				
Collector Emitter Saturation Voltage					0.5	V
at $I_C$ = 500 mA, $I_B$ = 50 mA		V <sub>CE(sat)</sub>			0.5	V
Base Emitter On Voltage		V			1	V
at $V_{CE}$ = 2 V, $I_C$ = 500 mA		$V_{BE}$			I	V
Transition Frequency			100			NALI-
at $V_{CE}$ = 5 V, $I_{C}$ = 50 mA, f = 100 MHz		F⊤	100			MHz
Output Capacitance				6		
at $V_{CB}$ = 10 V, f = 1 MHz		$C_{ob}$		6		pF

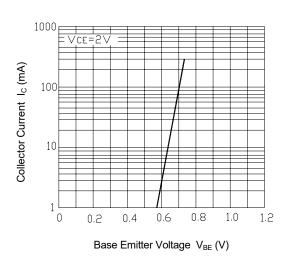


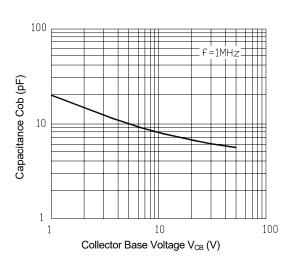
## **Typical Characteristic Curves**

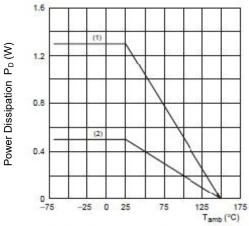












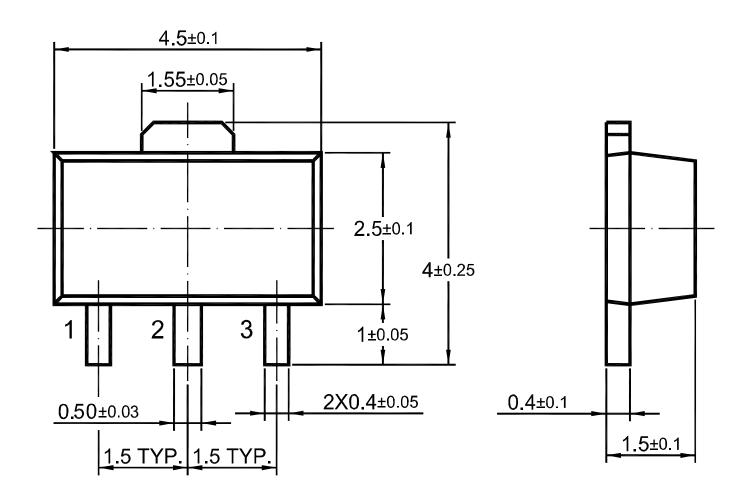
- (1) FR4 PCB, mounting pad for collector 6 cm<sup>2</sup>
- (2) FR4 PCB, standard footprint
  Ambient Temperature T<sub>a</sub> (°C)



# **Package Outline**

**SOT-89** 

Dimensions in mm



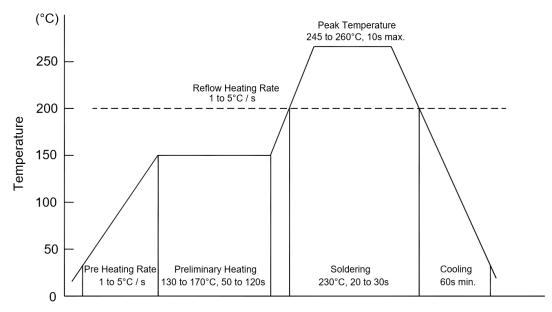
# **Ordering Information**

Device	Package	Shipping	
BCX56SQ	00 TO2	1,000PCS/Reel&7inches	
	SOT-89	3,000PCS/Reel&13inches	



## **Conditions of Soldering and Storage**

#### ♦ Recommended condition of reflow soldering



Recommended peak temperature is over 245 °C. If peak temperature is below 245 °C, you may adjust the following parameters:

- Time length of peak temperature (longer)
- Time length of soldering (longer)
- Thickness of solder paste (thicker)

#### Conditions of hand soldering

• Temperature: 370 °C

Time: 3s max.Times: one time

### ♦ Storage conditions

Temperature

5 to 40 °C

Humidity

30 to 80% RH

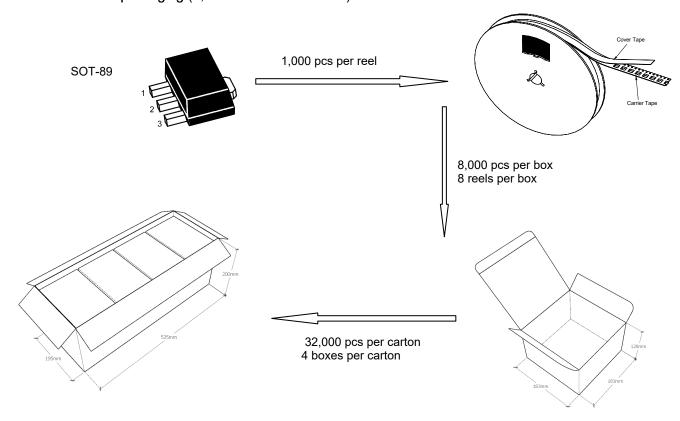
Recommended period

One year after manufacturing

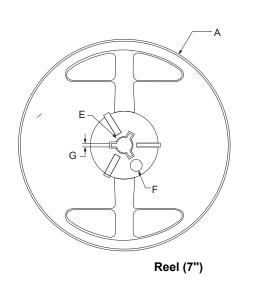


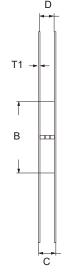
## **Package Specifications**

• The method of packaging (1,000PCS/Reel&7inches)

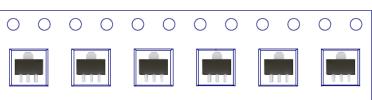


### ♦ Embossed tape and reel data





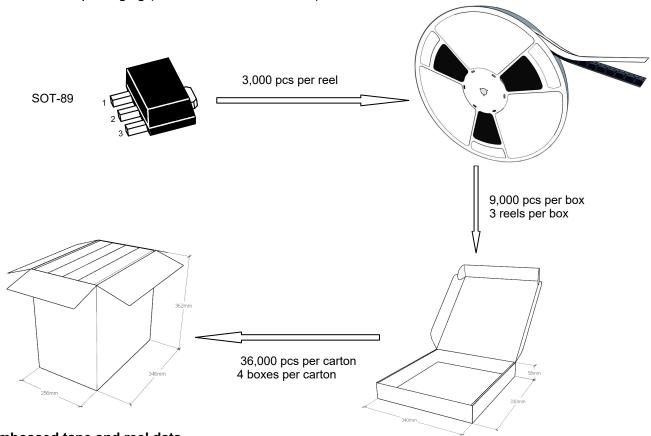
symbol	Value(unit:mm)	
Α	Ф179±1	
В	60.5±0.2	
С	15.3±0.3	
D	12.5~13.7	
Е	Ф13.5±0.2	
F	Ф10.0±0.2	
G	2.7±0.2	
 T1	1 0+0 2	



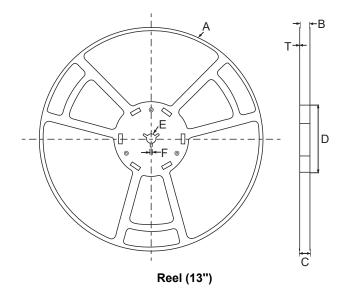


## **Package Specifications**

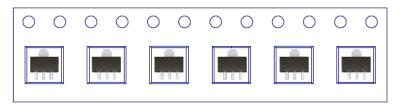
The method of packaging (3,000PCS/Reel&13inches)



## Embossed tape and reel data



symbol	Value(unit:mm)
Α	Ф330±1
В	12.7±0.5
С	16.5±0.3
D	Ф99.5±0.5
Е	Ф13.6±0.3
F	2.8±0.3
T1	1.9±0.2





#### **Contact Information**

For additional information, please contact your local Sales Representative.



® is registered trademarks of TANI Corporation.

#### **Product Specification Statement**

The product specification aims to provide users with a reference regarding various product parameters, performance, and usage. It presents certain aspects of the product's performance in graphical form and is intended solely for users to select product and make product comparisons, enabling users to better understand and evaluate the characteristics and advantages of the product. It does not constitute any commitment, warranty, or guarantee.

The product parameters described in the product specification are numerical values, characteristics, and functions obtained through actual testing or theoretical calculations of the product in an independent or ideal state. Due to the complexity of product applications and variations in test conditions and equipment, there may be slight fluctuations in parameter test values. TANI shall not guarantee that the actual performance of the product when installed in the customer's system or equipment will be entirely consistent with the product specification, especially concerning dynamic parameters. It is recommended that users consult with professionals for product selection and system design. Users should also thoroughly validate and assess whether the actual parameters and performance when installed in their respective systems or equipment meet their requirements or expectations. Additionally, users should exercise caution in verifying product compatibility issues, and TANI assumes no responsibility for the application of the product. TANI strives to provide accurate and up -to- date information to the best of our ability. However, due to technical, human, or other reasons, TANI cannot guarantee that the information provided in the product specification is entirely accurate and error-free. TANI shall not be held responsible for any losses or damages resulting from the use or reliance on any information in these product specifications.

TANI reserves the right to revise or update the product specification and the products at any time without prior notice, and the user's continued use of the product specification is considered an acceptance of these revisions and updates. Prior to purchasing and using the product, users should verify the above information with TANI to ensure that the product specification is the most current, effective, and complete. If users are particularly concerned about product parameters, please consult TANI in detail or request relevant product test reports. Any data not explicitly mentioned in the product specification shall be subject to separate agreement.

Users are advised to pay attention to the parameter limit values specified in the product specification and maintain a certain margin in design or application to ensure that the product does not exceed the parameter limit values defined in the product specification. This precaution should be taken to avoid exceeding one or more of the limit values, which may result in permanent irreversible damage to the product, ultimately affecting the quality and reliability of the system or equipment.

The design of the product is intended to meet civilian needs and is not guaranteed for use in harsh environments or precision equipment. It is not recommended for use in systems or equipment such as medical devices, aircraft, nuclear power, and similar systems, where failures in these systems or equipment could reasonably be expected to result in personal injury. TANI shall assume no responsibility for any consequences resulting from such usage.

Users should also comply with relevant laws, regulations, policies, and standards when using the product specification. Users are responsible for the risks and liabilities arising from the use of the product specification and must ensure that it is not used for illegal purposes. Additionally, users should respect the intellectual property rights related to the product specification and refrain from infringing upon any third- party legal rights. TANI shall assume no responsibility for any disputes or controv ersies arising from the above-mentioned issues in any form.